

Product Compliance Declaration

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Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0353632060 Part Weight 1.2336G

Part Name 2.0MM W/B CONN (R/A) ASSY 353632010

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
2.0MM W/B CONN (R/A) ASSY 353632010	Assembly		100	1.2336	
20 WB CONN WAFERRA	Component		59.8249	0.738	
PA66-FR(30)	Material		59.8249	0.738	
PA66	Substance		51.599	0.636525	
Flame Retardant, ISO 1043-4 FR(30)	Substance		4.786	0.05904	
Further Additives, not to declare	Substance	system	0.5982	0.00738	
Pigment portion, not to declare	Substance	system	0.4487	0.005535	
Antimonytrioxide	Substance	1309-64-4	2.393	0.02952	
SQ Loose Pin Plated_mm	Component		40.1751	0.4956	
Brass C2700	Material		40.0616	0.494199	
Copper	Substance	7440-50-8	26.5914	0.328031	
Lead	Substance	7439-92-1	0.0119 0.00014		
Iron	Substance	7439-89-6	0.0119 0.000147		

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Type CAS Number		Proportion (% Total)	Mass (Grams)
Zinc (metal)	Substance	7440-66-6	13.4464	0.165875
Electro Tin Plating	Material		0.0487	0.0006
Tin	Substance	7440-31-5	0.0487	0.0006
Electro Copper Plating	Material		0.0649	0.0008
Copper	Substance	7440-50-8	0.0649	0.0008

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Not reviewed

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

None

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HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0353632060							
Part Name	2.0MM W/B CONN (R/A) ASSY 353632010	(e)						
Part Information	on			Ha	zardous S	Substance	es	
Components			Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
2.0MM W/B (CONN (R/A) ASSY 353632010		0	0	0	0	0	0
20 WB CON	N WAFERRA		0	0	0	0	0	0
SQ Loose Pi	n Plated_mm		0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	MSn
Termination Base Alloy	Brass
Solder Alloy	SnAgCu
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Mar 25, 2021